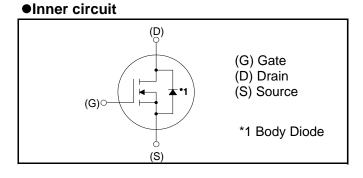


V _{DSS}	650V
R _{DS(on)} (Typ.)	120m Ω
I _D	29A* ¹

- Features
- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive



Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

•Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	650	V
Continuous drain current $T_c = 25^{\circ}C$		Ι _D ^{*1}	29	A
Pulsed drain current		I _{D,pulse} *2	72	А
Gate - Source voltage (DC)		V _{GSS}	-6 to 22	V
Gate - Source surge voltage (T _{surge} < 300nsec)		V _{GSS-surge} *3	-10 to 26	V
Junction temperature		Τ _j	175	°C
Range of storage temperature		T _{stg}	-55 to +175	°C

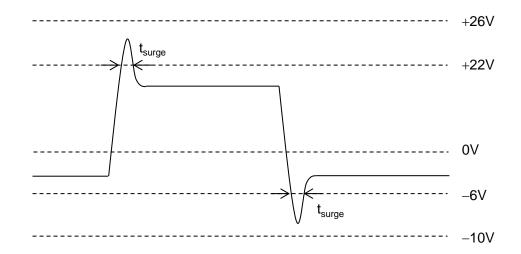
•Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumbol	Conditions	Values			L locit	
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 1mA$	650	-	-	V	
		$V_{DS} = 650V, V_{GS} = 0V$					
Zero gate voltage drain current	I _{DSS}	T _j = 25°C	-	1	10	μA	
		T _j = 150°C	-	2	-		
Gate - Source leakage current	I_{GSS^+}	$V_{GS} = +22V, V_{DS} = 0V$	-	-	100	nA	
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -6V, V_{DS} = 0V$	-	-	-100	nA	
Gate threshold voltage	V _{GS (th)}	$V_{DS} = V_{GS}, I_D = 3.3 \text{mA}$	1.6	2.8	4.0	V	
		$V_{GS} = 18V, I_{D} = 10A$					
Static drain - source on - state resistance	$R_{DS(on)}$ *4	T _j = 25°C	-	120	156	mΩ	
		T _j = 125°C	-	149	-		
Gate input resistance	R _G	f = 1MHz, open drain	-	13.8	-	Ω	

*1 Limited only by maximum temperature allowed.

*2 PW \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 Example of acceptable Vgs waveform



*4 Pulsed

•Electrical characteristics ($T_a = 25^{\circ}C$)

Doromotor	Symbol	Conditions	Values			الم:4	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Transconductance	g_{fs} *4	$V_{DS} = 10V, I_{D} = 10A$	-	2.7	-	S	
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	1200	-		
Output capacitance	C _{oss}	$V_{DS} = 500V$	-	90	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	13	-		
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 300V	-	115	-	pF	
Turn - on delay time	t _{d(on)} *4	$V_{DD} = 300V, I_D = 10A$	-	22	-		
Rise time	t _r *4	V _{GS} = 18V/0V	-	31	-	20	
Turn - off delay time	t _{d(off)} *4	$R_L = 30\Omega$	-	60	-	ns	
Fall time	t _f *4	$R_{G} = 0\Omega$	-	19	-		
Turn - on switching loss	E _{on} *4	$V_{DD} = 300V, I_{D} = 10A$ $V_{GS} = 18V/0V$	-	61	-		
Turn - off switching loss	E _{off} *4	R _G = 0Ω, L=500μH *E _{on} includes diode reverse recovery	-	41	-	μJ	

•Gate Charge characteristics ($T_a = 25^{\circ}C$)

Parameter	Symbol Conditions -	Conditions	Values			1.1.0.14
		Min.	Тур.	Max.	Unit	
Total gate charge	Q_g^{*4}	V _{DD} = 300V	-	61	-	
Gate - Source charge	Q_{gs}^{*4}	I _D = 10A	-	14	-	nC
Gate - Drain charge	Q_{gd}^{*4}	V _{GS} = 18V	-	21	-	
Gate plateau voltage	V _(plateau)	$V_{DD} = 300V, I_{D} = 10A$	-	10.4	-	V

•Body diode electrical characteristics (Source-Drain) ($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit	
Faranielei	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Inverse diode continuous, forward current	ا _S *1	-T _c = 25°C	-	-	29	А	
Inverse diode direct current, pulsed	I _{SM} *2		-	-	72	A	
Forward voltage	V_{SD} *4	$V_{GS} = 0V, I_{S} = 10A$	-	4.3	-	V	
Reverse recovery time	t _{rr} *4		-	33	-	ns	
Reverse recovery charge		I _F = 10A, V _R = 400V di/dt = 160A/μs	-	53	-	nC	
Peak reverse recovery current	^{*4}	αναί – 100/0μο	-	3.0	-	А	

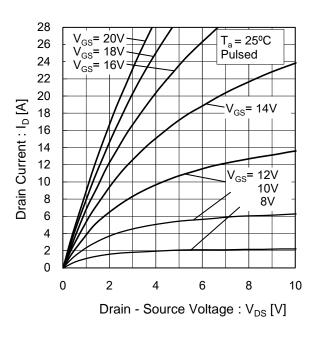
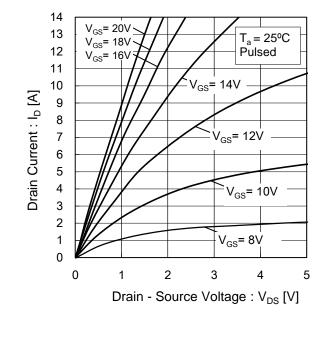


Fig.1 Typical Output Characteristics(I)

Fig.2 Typical Output Characteristics(II)



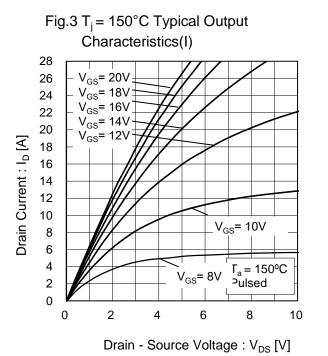
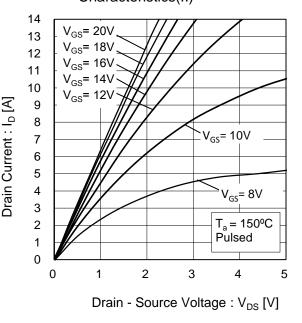


Fig.4 T_j = 150°C Typical Output Characteristics(II)



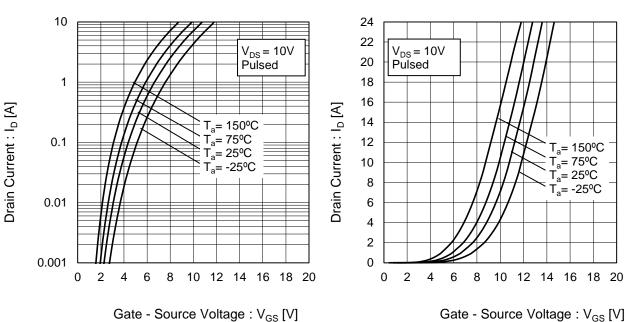


Fig.5 Typical Transfer Characteristics (I)

Fig.6 Typical Transfer Characteristics (II)

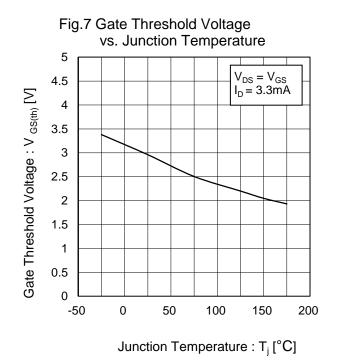
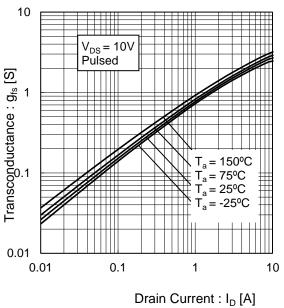
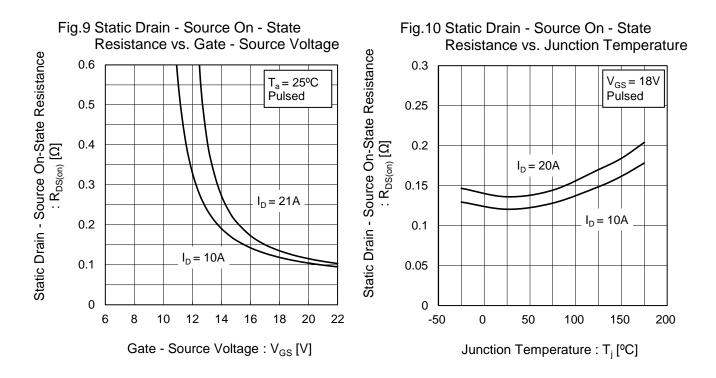
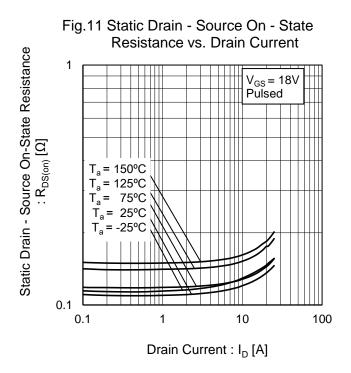


Fig.8 Transconductance vs. Drain Current







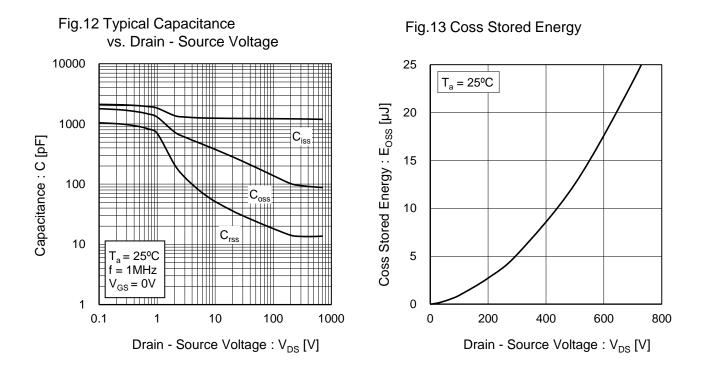
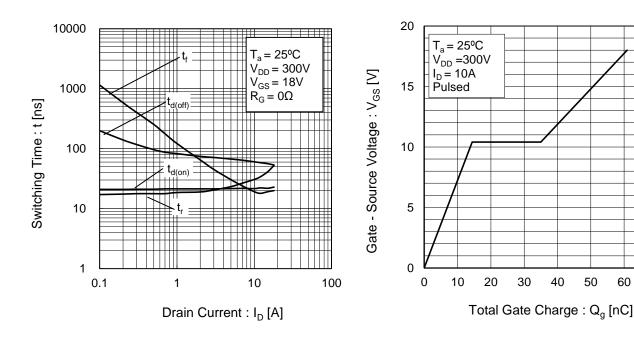


Fig.14 Switching Characteristics

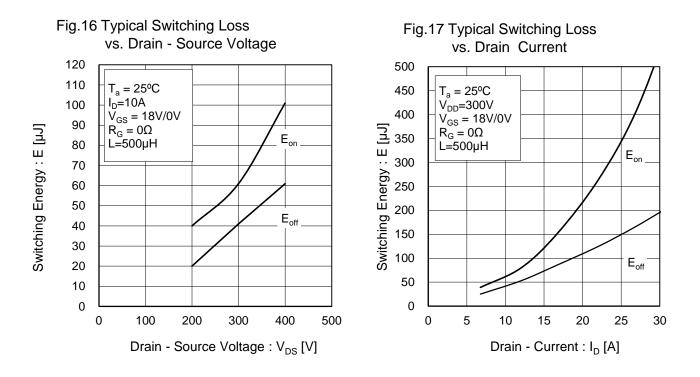
Fig.15 Dynamic Input Characteristics

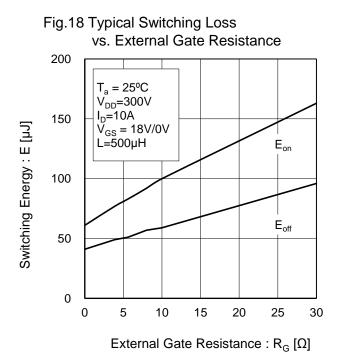


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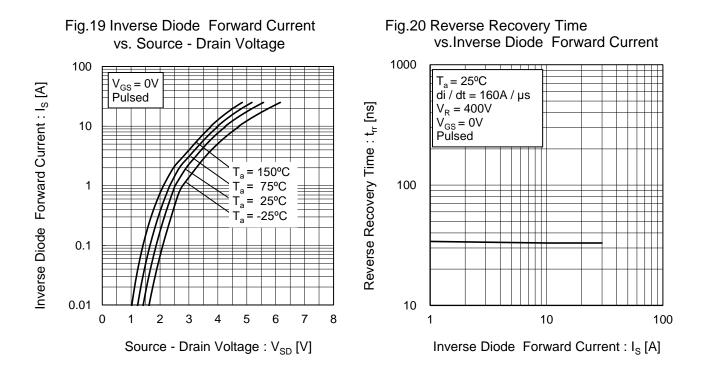
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60









Measurement circuits

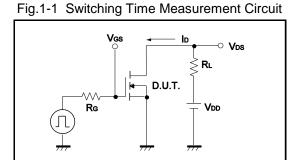


Fig.2-1 Gate Charge Measurement Circuit

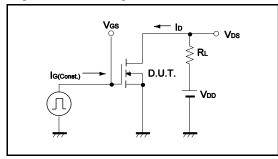


Fig.3-1 Switching Energy Measurement Circuit

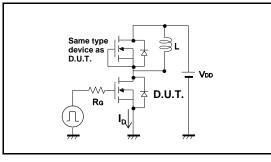
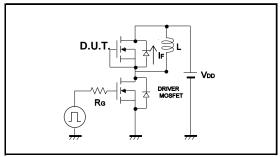


Fig.4-1 Reverse Recovery Time Measurement Circuit Fig.4-2 Reverse Recovery Waveform





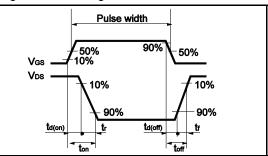


Fig.2-2 Gate Charge Waveform

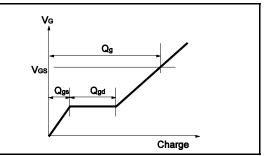
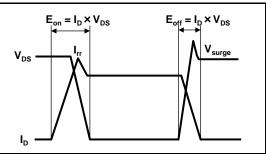
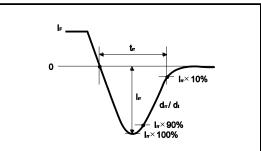


Fig.3-2 Switching Waveforms







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